ΤΑΤ7460 75 Ω 5V 50-2600MHz RF Amplifier

Applications

- Distribution Amplifiers
- Multi-Dwelling Units
- Drop Amplifiers
- Single-ended Gain Block
- FTTH Receivers

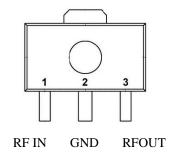
Product Features

- 50-2600 MHz bandwidth
- Low Noise Figure: 2.4 dB up to 1600 MHz
- Extremely Flat Gain Response
- Low Power Consumption: 100 mA with 5 V
- SOT-89 package





Functional Block Diagram



General Description

The TAT7460 is a 75 Ohm RF Amplifier designed for use up to 2600 MHz, addressing the CATV and Satellite bands in a single part. The TAT7460 is fabricated using 6-inch GaAs pHEMT technology to optimize performance and cost.

Pin Configuration

Pin #	Symbol
1	RF IN
2	GND
3	RF OUT
4	GND PADDLE

Ordering Information

Part No.	Description
TAT7460	75 Ω High linearity pHEMT amplifier (lead-free/RoHS compliant SOT-89 Pkg)
TAT7460-EB	Amplifier Evaluation Board

Standard T/R size = 1000 pieces on a 7" reel.

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Specifications

Absolute Maximum Ratings¹

Parameter	Rating
Device Voltage	+10.0 V
Operating Temperature	-40 to +85 °C
Storage Temperature	-65 to +150 °C

Notes:

1. Operation of this device outside the parameter ranges given above may cause permanent damage

Recommended Operating Conditions

Parameter	Min	Тур	Max	Units
V _{DD}	4.5	5	6.5	V
I _{DD}		100	120	mA
T_J (for > 10 ⁶ hours MTTF)			150	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

Test conditions unless otherwise noted: 25 °C case temperature. +5 V V_{DD}

Parameter	Conditions	Min	Typical	Max	Units
Operational Frequency Range		50		2600	MHz
Gain		16.1	16.5		dB
Gain Flatness			+/- 0.5		dB
Noise Figure	See Note 1		2.5		dB
Input Return Loss			18		dB
Output Return Loss			18		dB
CSO	See Note 2.		-61		dBc
СТВ	See Note 2.		-72		dBc
XMOD	See Note 2.		-71		
Output IP2	See Note 3.	56.2	58		dBm
Output IP3	See Note 3.	31.1	36		dBm
P1dB			20.5		dBm
V _{SUPPLY}			+5		V
I _{DD}			100	120	mA
Thermal Resistance (jnt to case) θ_{ic}			51		°C/W

Notes:

1. Up to 1600 MHz

2. 30 dBmV/ch at output, 80 ch flat

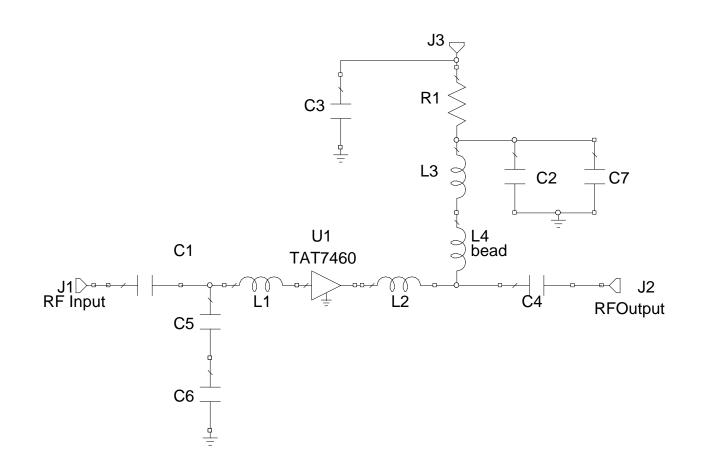
3.5 dBm/tone output with 100 MHz tone spacing

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TAT7460 *75* Ω *5V 50-2600MHz RF Amplifier*



Application Circuit Reference Design 50-2600 MHz



Application Circuit BOM 50-2600 MHz

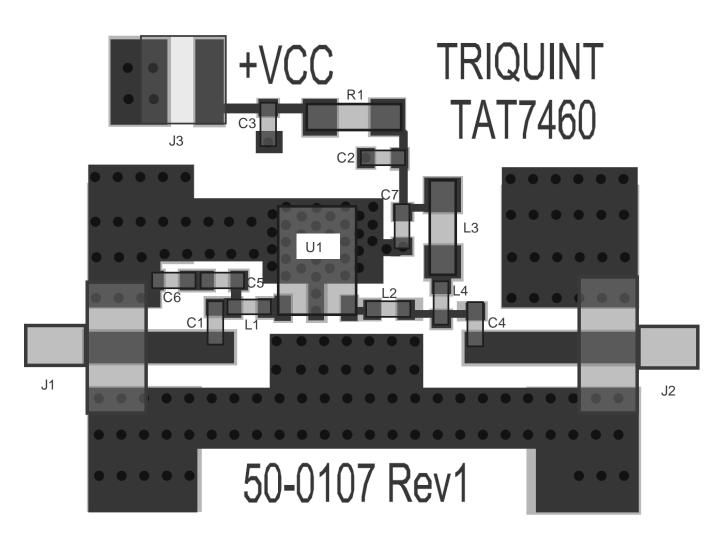
Bill of Material

Ref. Desg.	Value	Description	Manufacturer	Part Number
U1		75 Ω pHEMT Amplifier	TriQuint	TAT7460
C1	470 pF	Ceramic Cap, 0603, 16 V, 5%	Various	
C2, C3, C7	0.01 uF	Ceramic Cap, 0603, X7R, 16 V, 5 %	Various	
C4	390 pF	Ceramic Cap, 0603, 16 V, 5%	Various	
C5	0.7 pF	Ceramic Cap, 0603, 50 V, ±0.1 pF	Various	
C6	0.5 pF	Ceramic Cap, 0603, 50 V, ±0.1 pF	Various	
L1	3.6 nH	Wirewound Ind, 0603, 5%	Various	
L2	3.3 nH	Wirewound Ind, 0603, 5%	Various	
L3	880 nH	Wirewound Ind, 1206, 5%	Various	
L4	Bead	Ferrite Bead, 0402, 200 mA, 1.0 kΩ	Murata	BLM15AG102SN1
R1	0 Ω	Thick Film Res, 1206	Various	
J1, J2	Connector	F-Connector	Various	





Application Board Layout



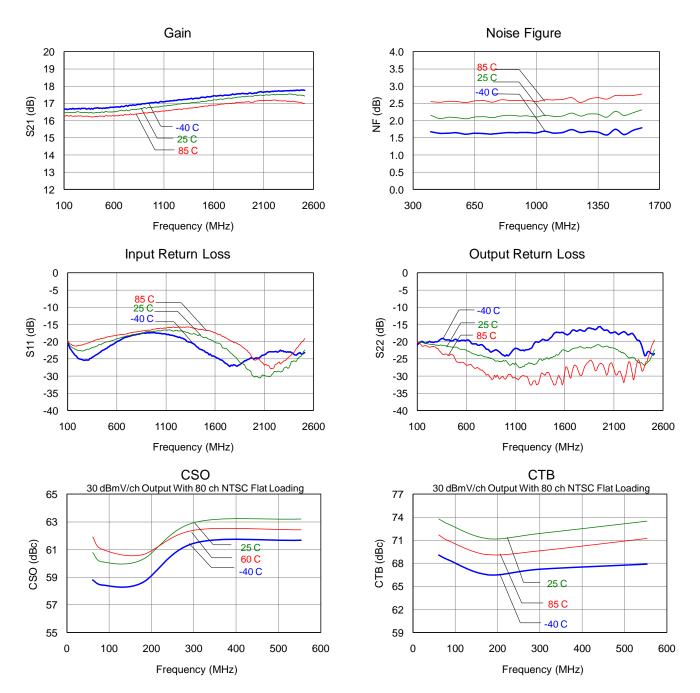


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Application Board Typical Performance

 V_{DD} = +5 V, I_{DD} = 100 mA, temperatures measured at the case of the device



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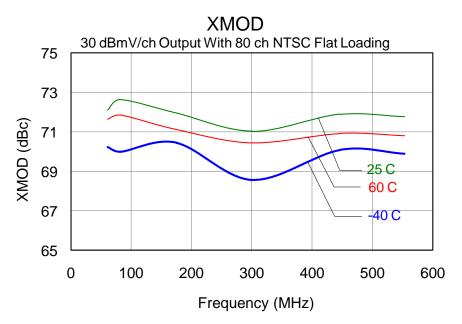
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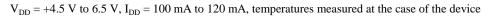


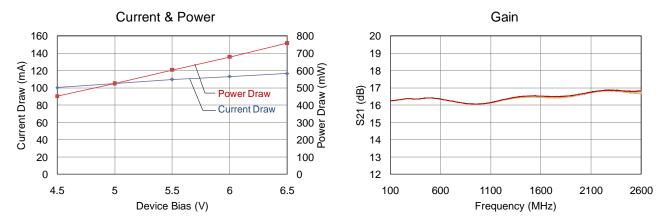
Application Board Typical Performance (continued)

 $V_{DD} = +5$ V, $I_{DD} = 100$ mA, temperatures measured at the case of the device



Application Board Typical Performance Over Bias



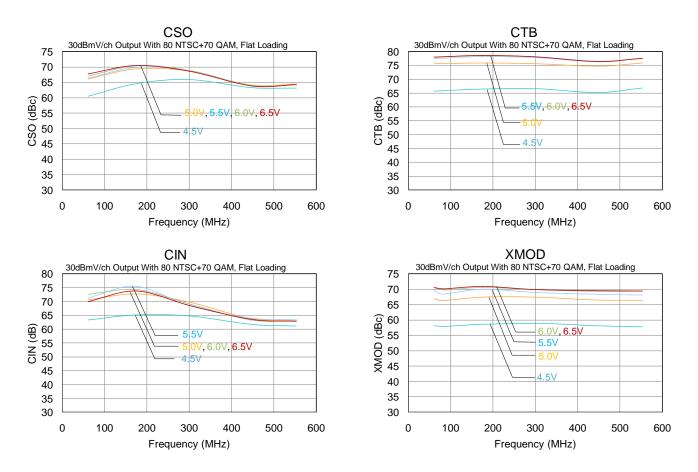


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Application Board Typical Performance Over Bias (continued)

 V_{DD} = +4.5 V to 6.5 V, I_{DD} = 100 mA to 120 mA, temperatures measured at the case of the device , 80 NTSC and 70 QAM channels, Flat



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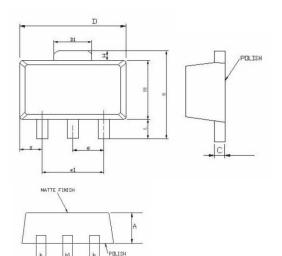
Mechanical Information

Package Information and Dimensions

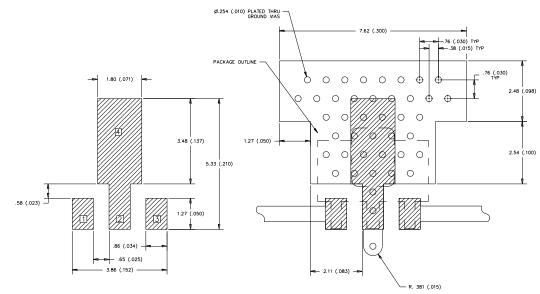
This package is lead-free/RoHS-compliant. The plating material on the leads is 100% Matte Tin. It is compatible with both lead-free (maximum 260 °C reflow temperature) and lead (maximum 245 °C reflow temperature) soldering processes.

The TAT7460 will be marked with a "TAT7460" designator and an 8 digit alphanumeric lot code (XXXXYYWW). The first four digits are the lot code (XXXX). The last four digits are a date code consisting of the year and work week (YYWW) of assembly.

	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
SAWBORZ	MIN	NDM	MAX	MIN	NDM	MAX
A	1.40	1.50	1,60	0.055	0.059	0.063
L	0.89	L.04	1.20	0.0350	0.041	0.047
b	0.36	0.42	0,48	0.014	0.016	0.018
b1	0.41	0.47	0.53	0.016	0.018	0.020
С	0.38	0.40	0.43	0.014	0.015	0.017
D	4.40	4.50	4.60	0.173	0.177	0.181
D1	1.40	1.60	1.75	0.055	0.062	0.069
E	3,64		4.25	0.143	-	0.167
E1	2.40	2.50	2.60	0.094	0.09B	0.102
el	2.90	3.00	3.10	0.114	0.118	0.122
Н	0.35	0.40	0.45	0.014	0.016	0.018
2	0.65	0.75	0.85	0.026	0.030	0.034
e	1.40	1.50	1.60	0.054	0.059	0.063



Mounting Configuration



Notes:

- 1. Ground / thermal vias are critical for the proper performance of this device. Vias should use a .35 mm (#80/.0135") diameter drill and have a final, plated thru diameter of .25 mm (.010").
- 2. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
- 3. RF trace width depends upon the PC board material and construction.

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4. All dimensions are in millimeters (inches). Angles are in degrees. **Product Compliance Information**

ESD Information



ESD Rating:	Class 1A+
Value:	Passes \geq 450 V min.
Test:	Human Body Model (HBM)
Standard:	JEDEC Standard JESD22-A114

ESD Rating:	Class IV
Value:	Passes $\geq 1000 \text{ V min.}$
Test:	Charged Device Model (CDM)
Standard:	JEDEC Standard JESD22-C101

MSL Rating

Level 3 at +260 °C convection reflow. The part is rated Moisture Sensitivity Level 3 at 260°C per JEDEC standard IPC/JEDEC J-STD-020.

Contact Information

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Solderability

Compatible with the latest version of J-STD-020, Lead free solder, 260 °C.

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).